

# **DRD560G90**

## **Rectifier Diode**

Replaces DS6066-5 DS6066-6 August 2022 (LN41981)

#### **FEATURES**

- Double Side Cooling
- High Surge Capability

### **KEY PARAMETERS**

VRRM 9000V IF(AV) 530A IFSM 7650A

### **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages VRRM (V)	Conditions
DRD560G90	9000	
DRD560G85	8500	VRSM = VRRM + 100V
DRD560G80	8000	

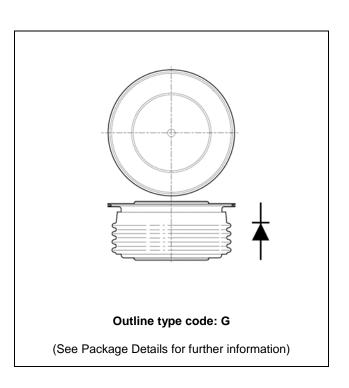


Fig. 1 Package outline

### **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DRD560G85 for an 8500V device

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

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## **CURRENT RATINGS**

## T<sub>case</sub> = 75°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
<b>I</b> F(AV)	Mean forward current	Half wave resistive load	660	А			
IF(RMS)	RMS value	-	1040	А			
İF	Continuous (direct) forward current	-	1010	А			
Single Side Cooled							
<b>I</b> F(AV)	Mean forward current	Half wave resistive load	450	А			
IF(RMS)	RMS value	-	710	А			
İF	Continuous (direct) forward current	-	650	А			

## T<sub>case</sub> = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
<b>I</b> F(AV)	Mean forward current	Half wave resistive load	530	А			
IF(RMS)	RMS value	-	830	Α			
lF	Continuous (direct) forward current	-	810	Α			
Single Sic	Single Side Cooled						
lf(AV)	Mean forward current	Half wave resistive load	360	А			
IF(RMS)	RMS value	-	570	Α			
lF	Continuous (direct) forward current	-	510	Α			

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## **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
IFSM	Surge (non-repetitive) forward current	10ms half sine, Tcase = 150°C	7.65	kA
l²t	I <sup>2</sup> t for fusing	V <sub>R</sub> = 0	0.29	MA <sup>2</sup> s

## THERMAL AND MECHANICAL RATINGS

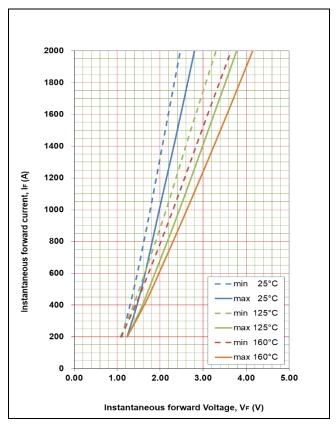
Symbol	Parameter	Test Conditions		Min.	Max.	Units
Rth(j-c)	Thermal resistance - junction to case	Double side cooled	DC	-	32.0	°C/kW
		Single side cooled	Anode DC	-	64.0	°C/kW
			Cathode DC	-	64.0	°C/kW
Rth(c-h)	Thermal resistance - case to heatsink	Clamping force 12kN (with mounting compound)	Double side	-	8.0	°C/kW
			Single side	ı	16.0	°C/kW
Tvj	Virtual junction temperature			-	160	°C
Tstg	Storage temperature range			-55	175	°C
Fm	Clamping force			11	13	kN

## **CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>FM</sub>	Forward voltage	At 1200A peak, Tcase = 160°C	-	2.95	V
<b>I</b> RM	Peak reverse current	At VRRM, Tcase = 160°C	-	100	mA
Qs	Total stored charge	IF = 1000A, dIRR/dt = 5A/µs, Tcase = 160°C, VR = 100V	2840	4300	μC
IRR	Peak reverse recovery current		90	115	Α
<b>V</b> TO	Threshold voltage	Tvj = 160°C	-	1.02	٧
<b>r</b> т	Slope resistance	Tvj = 160°C	-	1.57	mΩ

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### **CURVES**



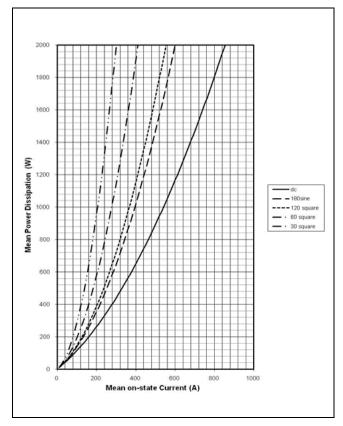


Fig. 2 Maximum & minimum on-state characteristics

Fig. 3 Dissipation curves

## **VFM EQUATION**

 $V_{FM} = A + B.ln(I_F) + C.I_F + D.\sqrt{I_F}$ 

Where A = 0.429684

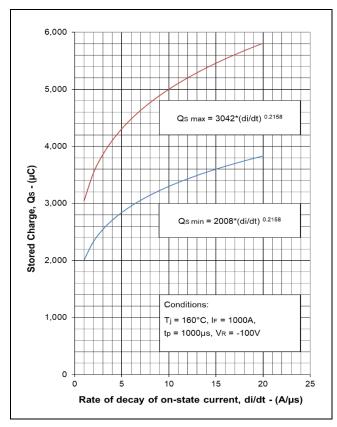
B = 0.061348

C = 0.001280

D = 0.015499

These values are valid for  $T_j = 160$ °C for  $I_F 200$ A to 2000A

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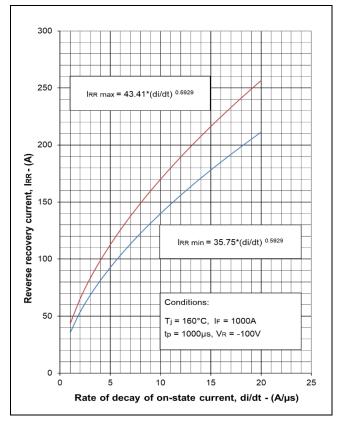


Fig. 4 Stored charge

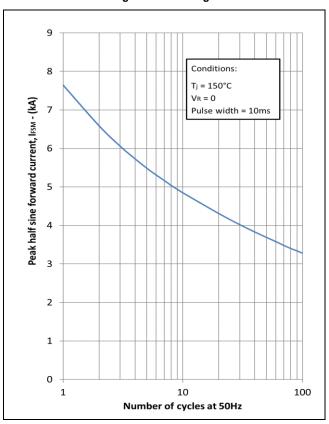


Fig. 6 Surge current vs number of half cycles @ 50Hz

Fig. 5 Reverse recovery current

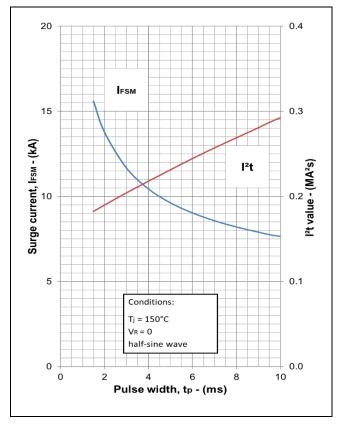


Fig. 7 Surge (non-repetitive) current vs pulse width

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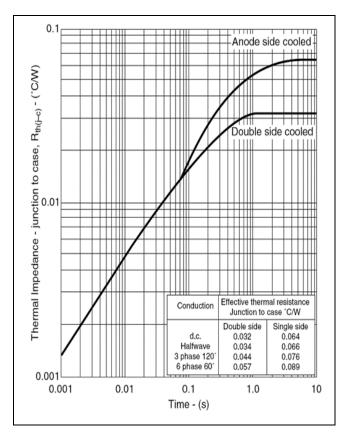


Fig. 8 Maximum (limit) transient thermal impedance - junction to case

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## **PACKAGE DETAILS**

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

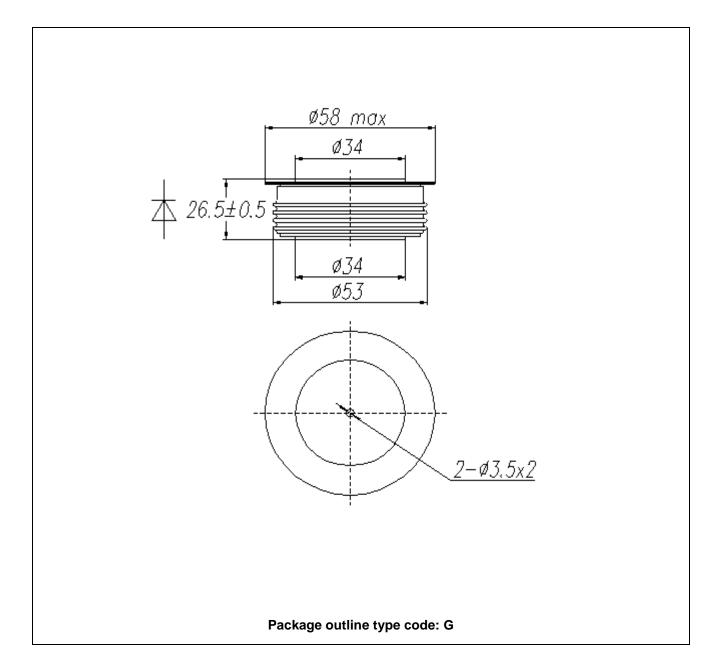


Fig. 8 Package outline

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